

Data sheet acquired from Harris Semiconductor SCHS066C- Revised October 2003

CMOS 8-Bit Addressable Latch

High-Voltage Types (20-Volt Rating)

■ CD4099B 8-bit addressable latch is a serial-input, parallel-output storage register that can perform a variety of functions.

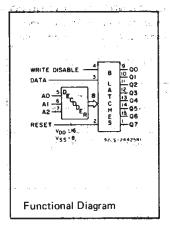
Data are inputted to a particular bit in the latch when that bit is addressed (by means of inputs A0, A1, A2) and when WRITE DISABLE is at a low level. When WRITE DISABLE is high, data entry is inhibited; however, all 8 outputs can be continuously read independent of WRITE DISABLE and address inputs.

A master RESET input is available, which resets all bits to a logic "0" level when RESET and WRITE DISABLE are at a high level. When RESET is at a high level, and WRITE DISABLE is at a low level, the latch acts as a 1-of-8 demultiplexer; the bit that is addressed has an active output which follows the data input; while all unaddressed bits are held to a logic "0" level.

The CD4099B types are supplied in 16-lead hermetic ceramic dual-in-line packages (F3A suffix), 16-lead plastic dual-in-line packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Features:

- Serial data input Active parallel output
- Storage register capability Master clear
- Can function as demultiplexer
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V (full package-temperature range), 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range) = 1 V at V_{DD} = 5 V, 2 V at V_{DD} = 10 V, 2.5 V at V_{DD} = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"



CD4099B Types

Applications:

- Multi-line decoders
- A/D converters

MAXIMUM RATINGS, Absolute-Maximum Values:	
DC SUPPLY-VOLTAGE RANGE, (VDD)	1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 -
Voltages referenced to V _{SS} Terminal)	0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	0.5V to V _{DD} +0.5V
DC INPUT CURRENT, ANY ONE INPUT	±10mA
POWER DISSIPATION PER PACKAGE (PD):	
For $T_A = -55^{\circ}C$ to $+100^{\circ}C$	500mW
For T _A = +100°C to +125°C	Derate Linearity at 12mW/°C to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package	Types)100mW
OPERATING-TEMPERATURE RANGE (TA)	55°C to +125°C
STORAGE TEMPERATURE RANGE (Tstg)	65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):	e te de la

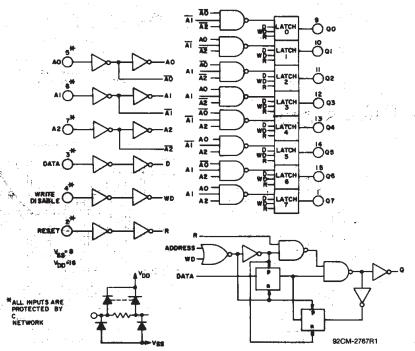
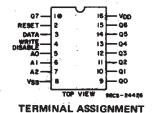


Fig. 1 — Logic diagram of CD4099B and detail of 1 of 8 latches.



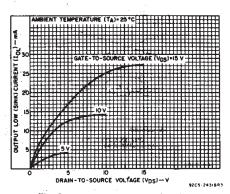


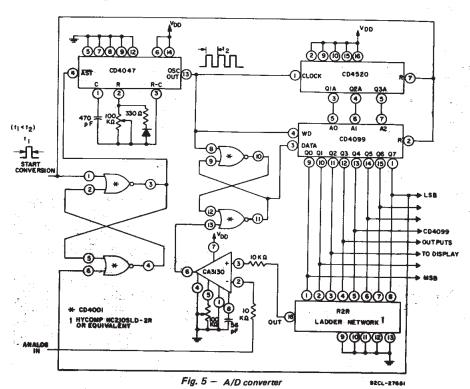
Fig. 2 — Typical output low (sink) current characteristics.

RECOMMENDED OPERATING CONDITIONS at $T_A = 25^{\circ}$ C (Unless otherwise specified) For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

CHARACTERISTIC	SEE	v_{DD}	LIN	UNITS		
	FIG. 15*	(V)	MIN.	MAX.	ONTS	
Supply Voltage Range: (At T _A = Full Package Temperature Range)			3	.18	V.	
Minimum Pulse Width, tW		5	200	-	-	
Data	(4)	10	100	_		
		15	80			
		5	400	_		
Address	(8)	10	200		ns	
		15	125	÷ .	-	
		5	150	. –		
Reset	(5)	10	75	_		
		15	50	_		
Setup Time, t _S		5	100	_		
Data to WRITE DISABLE	(6)	10	50	. –		
		15	35	-	ns	
Hold Time, tH		5	150	_		
Data to WRITE DISABLE		10	75		ns	
		15	50			

^{*} Circled numbers refer to times indicated on master timing diagram.

Note: In addition to the above characteristics, a WRITE DISABLE ON time (the time that WRITE DISABLE is at a high level) must be observed during an address change for the total time that the external address lines AO, A1, and A2 are settling to a stable level, to prevent a wrong cell from being addressed (see Fig. 3).



MODE SELECTION							
WD	R	ADDRESSED UNADDRESSEE LATCH					
0	0	Follows Data	Holds Previous State				
0	1	Follows Data Reset to "0" (Active High 8-Channel Demultiplexer)					
1	0	Holds Previous State					
1	1	Reset to "0"	Reset to "0"				

WD = WRITE DISABLE

R = RESET

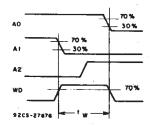


Fig. 3 - Definition of WRITE DISABLE ON time.

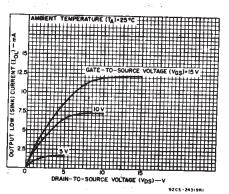


Fig. 4 — Minimum output low (sink) current characteristics.

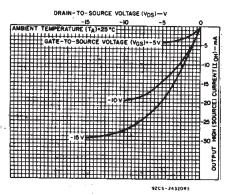
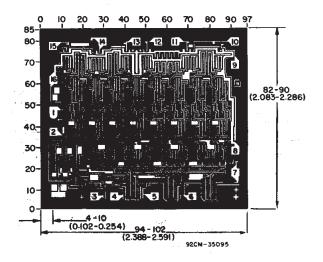


Fig. 6 - Typical output high (source) current characteristics.

STATIC ELECTRICAL CHARACTERISTICS

CHARACTER-	COND	ITION	ıs	LIMIT	rs at i	NDICAT	ED TEN	MPERATURES (°C)			UNITS
ISTIC	Vo.	VIN	v_{DD}			.05	.405		+25		Olaris
	(V)	(V)	(V)	-55	-40	+85	+125	Min.	Тур.	Max.	:
Quiescent Device		0,5	5	5	5	150	150	* -	0.04	5	
Current,	<u> </u>	0,10	10	10	10	300	300	_	0.04	10	μА
IDD Max.		0,15	15	20	20	600	600		0.04	20	μ
	-	0,20	20	100	100	3000	3000	-	0.08	100	
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1		_
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6	- .	
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3 4	6.8	_	
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA
(Source) Current, IOH Min.	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2		
	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	_	
	13.5	0,15	15	-4.2	4	-2.8	-2.4	-3.4	-6.8	-	
Output Voltage:	90 <u> </u>	0,5	5		0	.05		-	0	0.05	
Low-Level,	-	0,10	10		0	.05		-	0	0.05	
VOL Max.	_	0,15	15		0	.05		-	0	0.05	v
Output Voltage:	-	0,5	5	4.95				4.95	5	-	ľ
High-Level,	-	0,10	10		9	.95		9.95	10.	-"	
VOH Min.	-	0,15	15		14	1.95		14.95	15	-	
Input Low	0.5, 4.5	-	5		1	1.5		_	_	1.5	
Voltage,	1, 9	_	10			3		_	_	3	
VIL Max.	1.5,13.5	_	15			4		_	_	4	
Input High Voltage, VIH Min.	0.5, 4.5	-	5	3.5			3.5	_		٧	
	1, 9	-	10			7		7			
	1.5,13.5	-	15			11		11	_	_	
Input Current IIN Max.	_	0,18	18	±0.1	±0.1	,±1	±1	-	±10-5	±0,1	μА



CD4099BH DIMENSIONS AND PAD LAYOUT

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10⁻³ inch).

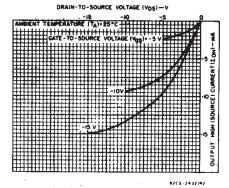


Fig.7 - Minimum output high (source) current characteristics.

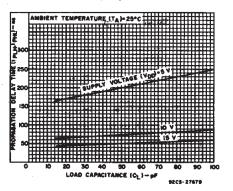


Fig. 8 — Typical propagation delay time (deta to Qn) vs. load capacitance.

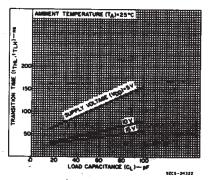


Fig. 9 — Typical transition time vs. load capacitance.

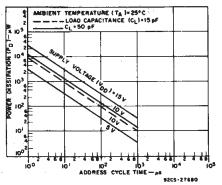


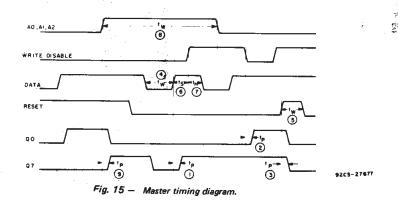
Fig. 10 — Typical dynamic power dissipation vs. address cycle time.

CD4099B Types

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25° C, C_L = 50 pF, Input t_F , t_f = 20 ns, R_L = 200 K Ω

CHARACTERISTIC	CONDI SEE FIG.15*	V _{DD}	LIMITS ALL PACKAGE TYPES TYP. MAX.		UNITS
Propagation Delay: tpLH,		5	200	400	
tPHL.	1	10	75	150	·
Data to Output,		15	50	100	
WRITE DISABLE	 	5	200	400	
to Output, tpLH,	(2)	10	80	160	ns
tPHL		15	60	120	
		5	175	350	,
Reset to Output,	3	10	80	160	
t _{PHL}		15	65	130	
Address to Output,		5	225	450	
tPLH,	9	10	100	200	
t _{PHL}		15	75	150	
Transition Time, t _{THL} ,		5	100	200	
(Any Output) t _{TLH}		10	50	100	ns
		15	40	80	
Minimum Pulse		5	100	200	
Width, t _W	4	10	50	100	ns
Data		15	40	. 80	
		5	200	400	<u>.</u>
Address	8	10	100	200	ns
		15	65	125	
		5	75	150	
Reset	⑤ [10	40	75	ns
		15	25	50	
Minimum Setup		5	50	100	
Time, tg	6	10	25	50	ns
Data to WRITE DISABLE		15	20	35	
Minimum Hold		5	75	150	
Time, t _H	0 [10	40	75	ns
Data to WRITE DISABLE		15	25	50	
Input Capacitance, CIN	Any Inp	ut	5	7.5	pF

^{*}Circled numbers refer to times indicated on master timing diagram.



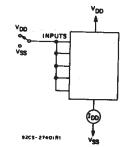


Fig. 11 — Quiescent device current test circuit.

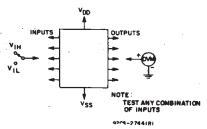


Fig. 12 - Input voltage test circuit.

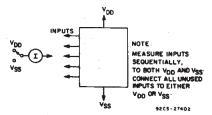


Fig. 13 - Input current test circuit.

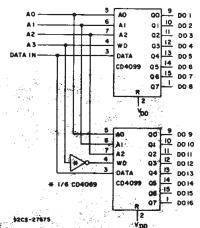


Fig. 14 - 1 of 16 decoder/demuttelexer.

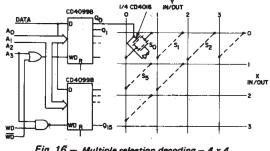


Fig. 16 — Multiple selection decoding — 4 x 4 crosspoint switch.





i.com 28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CD4099BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4099BF	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
CD4099BF3A	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
CD4099BM	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4099BM96	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4099BMT	ACTIVE	SOIC	D	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4099BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4099BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4099BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
JM38510/17601BEA	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

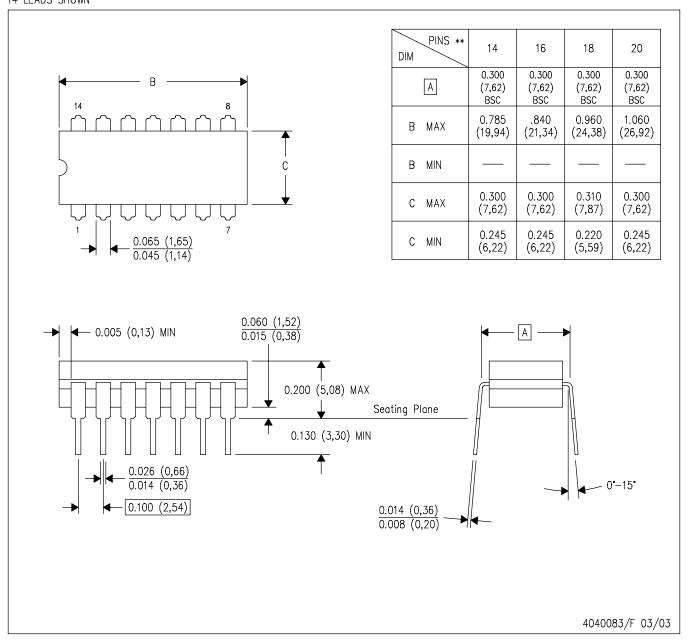
Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

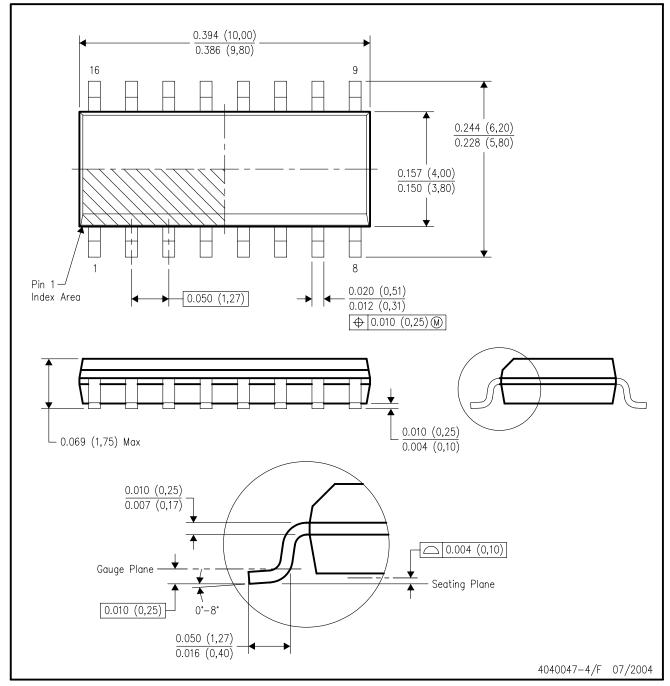


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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